## **AN6095SH**

# Reception IF + transmission quadrature modulation IC for PHS and cellular telephone

#### Overview

The AN6095SH is a single chip IC for PHS reception IF block and transmission block.

Reception IF block is incorporating a 2nd down-mixer and a limiter/RSSI circuit which can operate for up to 300 MHz of input frequency. Transmission block is incorporating a quadrature modulator, a phase shifter, an up-mixer for 1.9 GHz and output level control functions.

It contributes to realization of small package and small size of equipment.

#### ■ Features

• Operating supply voltage range: 2.7 V to 4.0 V

• Current consumption

Transmission block: 28 mA Reception block: 5.3 mA Sleep mode: 10 µA or less

(Transmission block)

• Output level: -8 dBm

• Output frequency: up to 2 GHz

• Transmission IF frequency: 100 MHz to 300 MHz

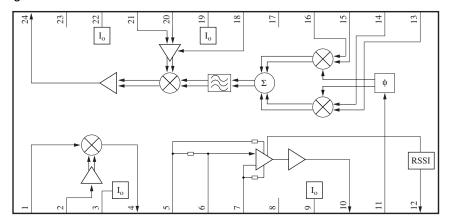
(Reception block)

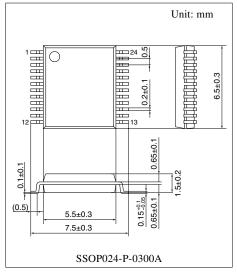
RSSI input D range: 80 dB
Mixer conversion gain: 16 dB
Limiter voltage gain: 70 dB
2nd down-mixer NF: 6 dB

## Applications

• PHS

#### ■ Block Diagram





Note) The package of this product will be changed to lead-free type (SSOP024-P-0300D). See the new package dimensions section later of this datasheet.

## ■ Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	RXMXIN	RX-mixer-in	13	Q-IN	Q-input
2	RXLOIN	RX-local-in	14	Q-IN	Q-input
3	VCCM	V <sub>CC</sub> -mixer	15	I-IN	I-input
4	MXO	Mixer-out	16	Ī-IN	Ī-input
5	LMDEC1	Limiter-decouple 1	17	GNDM	GND-TX-modulator
6	LMIN	Limiter-in	18	APC/BS	APC/BS
7	LMDEC2	Limiter-decouple 2	19	VCCM	V <sub>CC</sub> -TX-modulator
8	GNDR	GND-RX	20	TXLO2R	TX-local 2-REF
9	VCCL	V <sub>CC</sub> -limiter	21	TXLO2	TX-local 2
10	LMO	Limiter-out	22	VCCO	V <sub>CC</sub> -TX-out
11	TXLO1	TX-local 1-in	23	GNDO	GND-TX-out
12	RSO	RSSI-out	24	TXO	TX-output

## ■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	4.2	V	
Supply current	I <sub>CC</sub>	60	mA	
Power dissipation	$P_{\mathrm{D}}$	252	mW	
Operating ambient temperature *	T <sub>opr</sub>	-20 to +60	°C	
Storage temperature *	$T_{stg}$	-55 to +125	°C	

Note) 1. \*: Except for the operating ambient temperature and storage temperature, all ratings are for  $T_a = 25$  °C.

## ■ Recommended Operating Range

Parameter	Symbol	Range	Unit	
Supply voltage	V <sub>CC</sub>	2.7 to 4.0	V	

<sup>2.</sup> For the main characteristics, refer to "■ Technical Data".

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## ■ Electrical Characteristics at $T_a = 25$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Current consumption (reception)	I <sub>CCRX</sub>	No signal	_	5.3	6.8	mA
Mixer conversion gain	G <sub>MX</sub>	$V_{MI} = 70 \text{ dB}\mu$ Except for filter loss, SW1 = a	13	16	19	dB
Mixer maximum output level	V <sub>MX</sub>	$V_{MI} = 105 \text{ dB}\mu$ Except for filter loss, SW1 = a	105	110	_	dΒμ
Limiter voltage gain	$G_{LM}$	$V_{LI} = 20 \text{ dB}\mu, \text{ SW1} = \text{b}$	63	68	73	dB
Limiter maximum output amplitude	V <sub>LM</sub>	$V_{LI} = 80 \text{ dB}\mu, \text{ SW1} = \text{b}$	300	360	_	mV[p-p]
RSSI output voltage 1	$V_{S(1)}$	No signal, $SW1 = b$	0	0.2	0.5	V
RSSI output voltage 2	V <sub>S(2)</sub>	$V_{LI} = 115 \text{ dB}\mu, \text{ SW1} = \text{b}$	1.60	1.80	_	V
RSSI output slope	D <sub>S</sub>	$\begin{split} &V_{S}\left(V_{IS}\right) = V_{S(1)} + 0.15 \ V \\ &D_{S(1)} = V_{S} \left(V_{IS} + 65 \ dB\mu\right) - V_{S} \left(V_{IS}\right) \\ &SW1 = b \end{split}$	1.0	1.25	1.5	V
RSSI output slope variation	$\Delta D_{S(n)}$	$\begin{split} \Delta D_{S(n)} &= 5 \; \{ V_S \; (V_{IS} + n13 \; dB\mu) - \\ V_S \; (V_{IS} + (n-1) \; 13 \; dB\mu) \} \; / D_{S(1)} \\ n &= 1 \; to \; 5, \; SW1 = b \end{split}$	0.75	1.0	1.25	_
Current consumption (transmission)	I <sub>CCTX</sub>	Lo1 = 233.15 MHz, $-10 \text{ dBm}$ Lo2 = 1672.5 MHz, $-10 \text{ dBm}$ $V_{APC} = 2.75 \text{ V}$	_	28	37	mA
Sleep current at transmission	$I_{SL}$	No signal, $V_{APC} = 0 V$	_	0	10	μΑ
Transmission output level 1	P <sub>O1</sub>	Lo1 = 233.15 MHz, -10 dBm Lo2 = 1660 MHz, -10 dBm V <sub>APC</sub> = 2.75 V	-12	-8	_	dBm
Transmission output level 2	P <sub>O2</sub>	Lo1 = 233.15 MHz, -10 dBm Lo2 = 1685 MHz, -10 dBm V <sub>APC</sub> = 2.75 V	-12	-8	_	dBm

Note) 1. Refer to the "• Test circuit" for the SW1.

2. Unless otherwise specified:

At reception,  $V_{CC2} = 3.0 \text{ V}$ ,  $V_{LO3} = -10 \text{ dBm}$ : f = 233.15 MHz,  $V_{MI}$ : f = 243.95 MHz, SW1 = a

 $V_{LI}$ : f = 10.8 MHz (Input level of pin 6 except for attenuation of the matching circuit and filter.)

 $V_{MO}$  and  $V_{LO}$  are in high impedance measurement. ( $V_{LM}$  is measured with probe load of 27 pF and 1 M $\Omega$ .)

 $V_{IS}$  is an input level  $V_{LI}$  at which RSSI output voltage becomes  $V_{S(1)} + 0.15 \text{ V}$ .

At transmission,  $V_{CC1} = 3.0 \text{ V}$ , IQ signal amplitude: 0.4 V (both phases), DC bias: 1.5 V, SW1 = a

 $I_{CCTX}\!\!:\pi\!/4$  QPSK-modulated,  $P_{O1}$  and  $P_{O2}\!\!:$  PN9 stages modulated wave

Output frequency of  $P_{O1}$ : 1893.174 MHz Output frequency of  $P_{O2}$ : 1918.174 MHz

## ■ Electrical Characteristics at T<sub>a</sub> = 25°C (continued)

#### • Design reference data

Note) The characteristics listed below are theoretical values based on the IC design and are not guaranteed.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
1st local leak suppression amount	CL1	Lo1 = 233.15 MHz, -10 dBm Lo2 = 1672.5 MHz, -10 dBm V <sub>APC</sub> = 2.75 V	_	-25	_	dBc
2nd local leak suppression amount	CL2	Lo1 = 233.15 MHz, -10 dBm Lo2 = 1672.5 MHz, -10 dBm V <sub>APC</sub> = 2.75 V	_	-15	_	dBc
In-band output level deviation	ΔΡ	Lo1 = 233.15 MHz, $-10 \text{ dBm}$ Lo2 = 1660 to 1685 MHz, $-10 \text{ dBm}$ $V_{APC} = 2.75 \text{ V}$	_	±1.6	_	dB
Adjacent channel leak power suppression (600 kHz detuning)	BL1	Lo1 = 233.15 MHz, -10 dBm Lo2 = 1672.5 MHz, -10 dBm V <sub>APC</sub> = 2.75 V	_	-65	-60	dBc
Modulation precision	EVM	Lo1 = 233.15 MHz, -10 dBm Lo2 = 1672.5 MHz, -10 dBm V <sub>APC</sub> = 2.75 V	_	3	5	%[rms]
Minimum output level	P <sub>min</sub>	Lo1 = 233.15 MHz, $-10 \text{ dBm}$ Lo2 = 1672.5 MHz, $-10 \text{ dBm}$ $V_{APC} = 1.0 \text{ V}$	_	-45	-40	dBm
Image leak suppression	IL1	Lo1 = 233.15 MHz, $-10 \text{ dBm}$ Lo2 = 1672.5 MHz, $-10 \text{ dBm}$ $V_{APC}$ = 2.75 V IQ: Level is of no adjustment	_	-35	_	dBc
$f_{LO1} + f_{LO2}$ local leak suppression amount	CL	Lo1 = 233.15 MHz, $-10 \text{ dBm}$ Lo2 = 1672.5 MHz, $-10 \text{ dBm}$ $V_{APC}$ = 2.75 V IQ: DC offset is of no adjustment	_	-35	_	dBc
Proximity spurious suppression	DU	Lo1 = 233.15 MHz, $-10 \text{ dBm}$ Lo2 = 1672.5 MHz, $-10 \text{ dBm}$ Adjust $V_{APC}$ so as to get $P_{O}$ = $-12 \text{ dBm}$	_	-55	-51	dBc

Note) Unless otherwise specified:

At transmission,  $V_{CC1} = 3.0 \text{ V}$ , SW1 = a

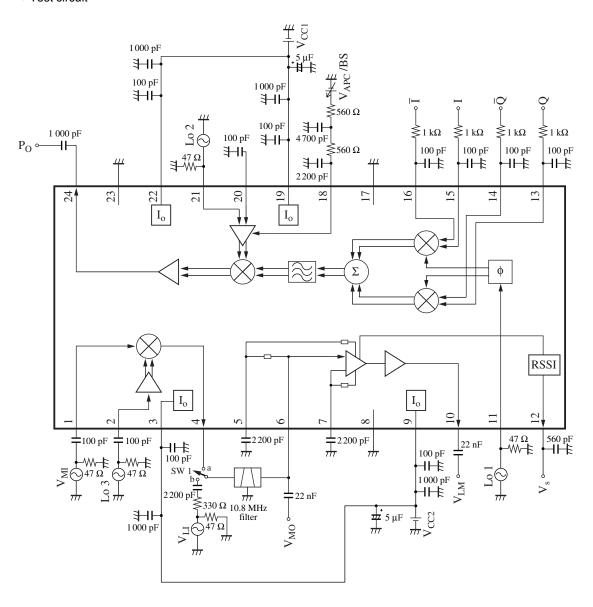
IQ signal: 0.4 V[p-p] (both phases), DC bias: 1.5 V

CL1, CL2,  $\Delta P,$  BL1, EVM,  $P_{min}$  , DU: PN9 stages modulated wave

IL1, CL:  $\pi/4$  QPSK-modulated

## ■ Electrical Characteristics (continued)

• Test circuit

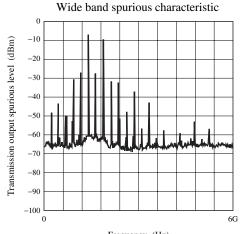


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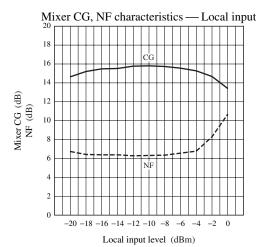
#### ■ Technical Data

Unless otherwise specified, the test condition is the same as "■ Electrical Characteristics". Characteristics are the theoretical values and not guaranteed ones.

## • Main characteristics (application circuit)



Frequency (Hz)

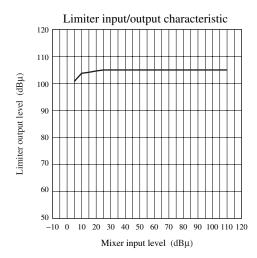


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RSSI characteristic

Mixer input level (dBµ)

10 20 30 40 50 60 70 80 90 100 110 120 130



 $(\overrightarrow{HB}) = 0 \\ (\overrightarrow{AB}) = 0 \\$ 

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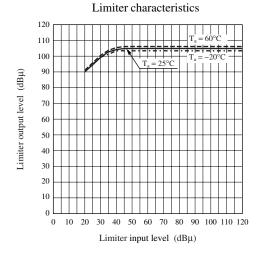
Mixer input level (dBµ)

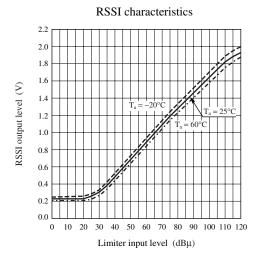
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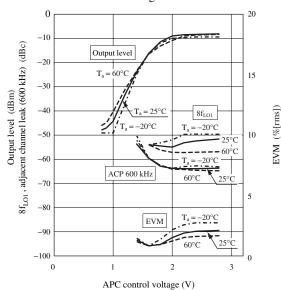
## ■ Technical Data (continued)

• Main characteristics (application circuit) (continued)





#### APC control voltage characteristics

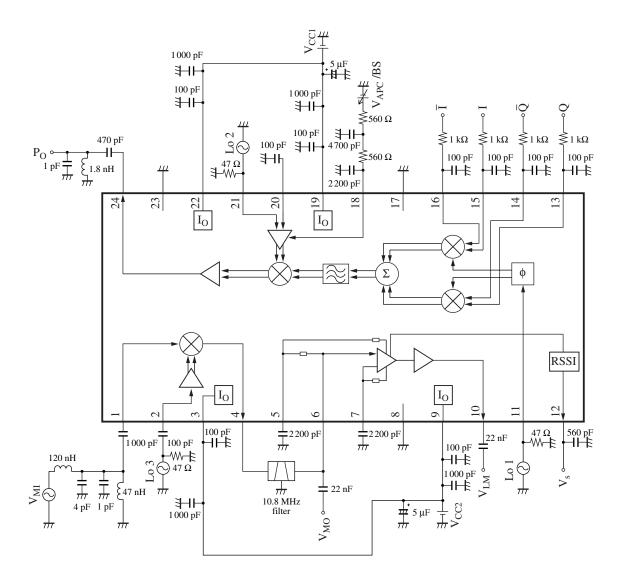


 $V_{CC} = 3.0 \text{ V}$ 

Lo1: 233.15 MHz, -10 dBm Lo2: 1672.5 MHz, -10 dBm

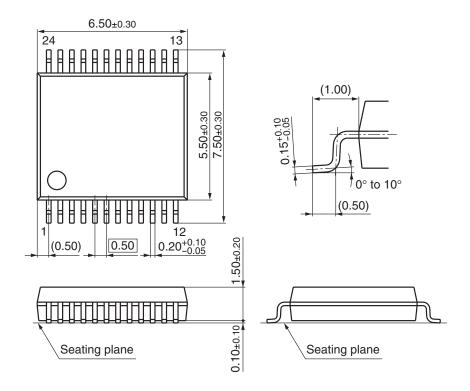
IQ: 0.4 V[p-p] (double phase),  $1.5 \text{ V}_{DC}$ , using PN9 stages continuous wave

## ■ Application Circuit Example



At CG/NF measurement, set pin 4 output as the right figure. 270  $\Omega$ 

- New Package Dimensions (Unit: mm)
- SSOP024-P-0300D (Lead-free package)



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